

**BYQ60W-600PT2** 

Ultrafast power diode Rev.02 - 12 November 2020

**Product data sheet** 

#### 1. General description

Ultrafast power diode in a TO247-2L plastic package.

#### 2. Features and benefits

- · Fast switching and soft reverse recovery characteristics
- Low forward voltage drop
- Low leakage current
- Low reverse recovery current
- Reduces switching losses in associated MOSFET or IGBT
- High operating temperature capability (T<sub>i (max)</sub> = 175°C)

#### 3. Applications

- UPS
- EV Charger
- Welding Machine
- Air Conditioner

#### 4. Quick reference data

Table 1. Q	uick reference data						
Symbol	Parameter	Conditions	Values				Unit
Absolute	maximum rating						
$V_{\text{RRM}}$	repetitive peak reverse voltage			6	00		V
$I_{F(AV)}$	average forward current	δ = 0.5 ; square-wave pulse; T <sub>mb</sub> ≤ 129 °C; Fig. 1; Fig. 2; Fig. 3	60			A	
I <sub>FRM</sub>	repetitive peak forward current	δ = 0.5 ; t <sub>p</sub> = 25 μs; T <sub>mb</sub> ≤ 129 °C; square-wave pulse	120			A	
I <sub>FSM</sub>	non-repetitive peak forward current	t <sub>p</sub> = 10 ms; T <sub>j(init)</sub> = 25 °C; sine-wave pulse; <u>Fig. 4</u>				A	
		$t_{\text{p}}$ = 8.3 ms; $T_{\text{j(init)}}$ = 25 °C; sine-wave pulse				А	
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Static ch	aracteristics						
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 60 A; T <sub>j</sub> = 25 °C; <u>Fig. 6</u>		-	1.55	2	V
		I <sub>F</sub> = 60 A; T <sub>j</sub> = 150 °C; <u>Fig. 6</u>		-	1.2	1.6	V
Dynamic	characteristics						
t <sub>rr</sub>	reverse recovery time	$I_F = 1 \text{ A}; V_R = 30 \text{ V}; dI_F/dt = 50 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 7$		-	-	55	ns

## **5. Pinning information**

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode		
2	А	anode		K <u> </u>
mb	mb	mounting base; connected to cathode	С С С Ц Ц Ц Ц Ц Ц Ц Ц Ц Ц Ц Ц Ц Ц Ц Ц Ц	

## 6. Ordering information

Table 3. Ordering information								
	Type number	Package name	Orderable part number	Packing method	Small packing quantity	•	Package issue date	
	BYQ60W-600PT2	TO247-2L	BYQ60W-600PT2Q	Tube	30	TO247L-2L	10-Nov-2020	

### 7. Marking

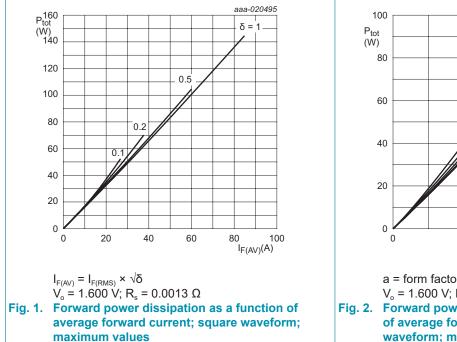
Table 4. Marking codes					
Type number	Marking codes				
BYQ60W-600PT2	BYQ60W 600PT2				

#### 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Values	Unit
V <sub>RRM</sub>	repetitive peak reverse voltage		600	V
$V_{\text{RWM}}$	crest working reverse voltage		600	V
V <sub>R</sub>	reverse voltage	DC	600	V
$\mathbf{I}_{F(AV)}$	average forward current	δ = 0.5 ; square-wave pulse; T <sub>mb</sub> ≤ 129 °C; Fig. 1; Fig. 2; Fig. 3	60	A
I <sub>FRM</sub>	repetitive peak forward current	δ = 0.5 ; t <sub>p</sub> = 25 μs; T <sub>mb</sub> ≤ 129 °C; square-wave pulse	120	A
I <sub>FSM</sub>	non-repetitive peak forward current	$t_p$ = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; Fig. 4	600	A
		$t_p$ = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse	660	A
l <sup>2</sup> t	limiting Joule-integral	SIN; t <sub>p</sub> = 10 ms	1800	A <sup>2</sup> s
T <sub>stg</sub>	storage temperature		-55 to 175	°C
Tj	junction temperature		175	°C



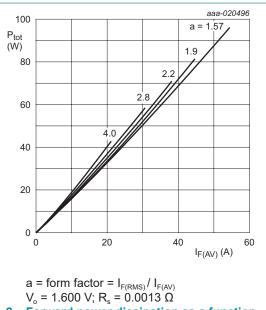
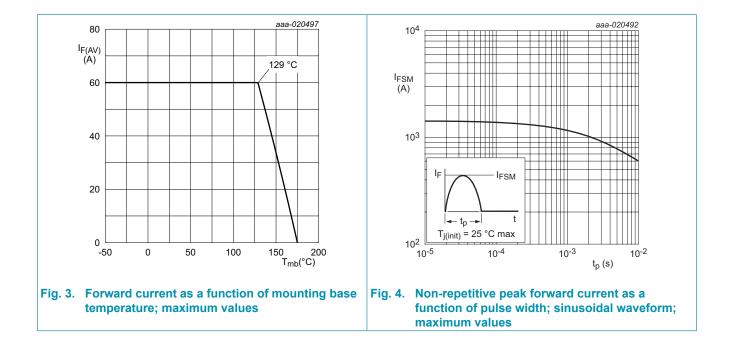


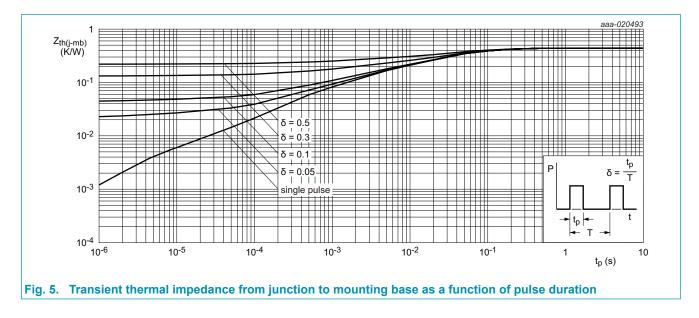
Fig. 2. Forward power dissipation as a function of average forward current; sinusoidal waveform; maximum values

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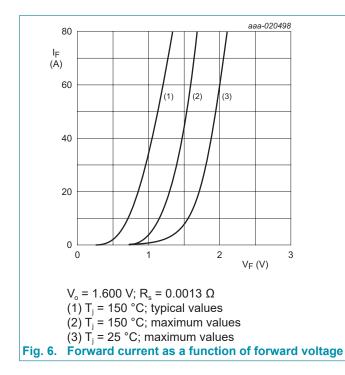
### 9. Thermal characteristics

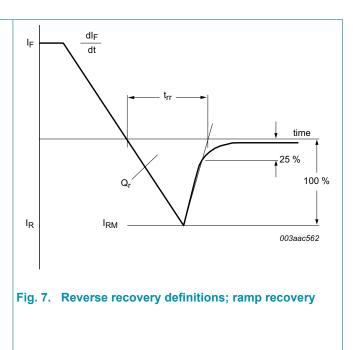
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{\text{th(j-mb)}}$	thermal resistance from junction to mounting base	<u>Fig. 5</u>	-	-	0.44	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient free air	in free air	-	45	-	K/W



### **10. Characteristics**

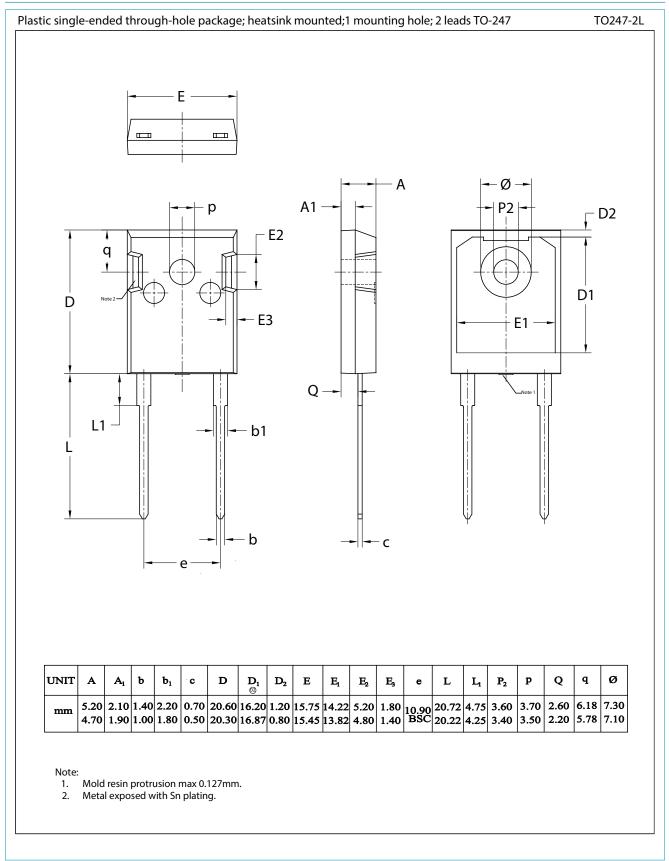
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static ch	aracteristics		I			
$V_{F}$	forward current	I <sub>F</sub> = 60 A; T <sub>j</sub> = 25 °C; <u>Fig. 6</u>	-	1.55	2	V
		I <sub>F</sub> = 60 A; T <sub>j</sub> = 150 °C; <u>Fig. 6</u>	-	1.2	1.6	V
I <sub>R</sub>	reverse current	V <sub>R</sub> = 600 V; T <sub>j</sub> = 25 °C	-	-	10	μA
		V <sub>R</sub> = 600 V; T <sub>j</sub> = 125 °C	-	-	500	μA
Dynamic	characteristics	· · · · ·				
Q <sub>r</sub>	reverse charge	$    I_F = 60 \text{ A};  \text{V}_R = 400 \text{ V};  \text{d}_F/\text{d}t = 200 \text{ A}/\mu\text{s}; \\ \text{T}_j = 25 ^\circ\text{C};  \overline{\text{Fig. } 7} $	-	143	-	nC
		$I_F = 60 \text{ A}; V_R = 400 \text{ V}; \text{ d}_F/\text{d}t = 200 \text{ A}/\mu\text{s};$ $T_j = 125 \text{ °C}; Fig. 7$	-	876	-	nC
t <sub>rr</sub>	reverse recovery time	$I_F = 1 \text{ A}; V_R = 30 \text{ V}; \text{ d}_F/\text{d}t = 50 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; \text{ Fig. 7}$	-	-	55	ns
		$I_F = 60 \text{ A}; V_R = 400 \text{ V}; \text{ d}I_F/\text{d}t = 200 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 7$	-	53	-	ns
		$I_F = 60 \text{ A}; V_R = 400 \text{ V}; \text{ d}_F/\text{d}t = 200 \text{ A}/\mu\text{s};$ $T_j = 125 \text{ °C}; Fig. 7$	-	120	-	ns
I <sub>RM</sub>	peak reverse recovery current	$I_F = 60 \text{ A}; V_R = 400 \text{ V}; \text{ d}_F/\text{d}t = 200 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 7$	-	5.4	-	A
		I <sub>F</sub> = 60 A; V <sub>R</sub> = 400 V; dI <sub>F</sub> /dt = 200 A/μs; T <sub>i</sub> = 125 °C; <u>Fig. 7</u>	-	14.5	-	А





#### BYQ60W-600PT2 Ultrafast power diode

#### **11. Package outline**



BYQ60W-600PT2 Product data sheet

# BYQ60W-600PT2

#### Ultrafast power diode

### 12. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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